



ATLAS
EXPERIMENT

RPC assembly for the ATLAS Phase-II upgrade

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2024年第十届中国LHC物理会议
山东省, 青岛市



Outline

- **Introduction**
- **Readout panel production**
- **BIS singlet assembly**

High-Luminosity LHC

High-Luminosity LHC (Phase-II) is expected to start in 2029 after LHC Long Shutdown 3 (LS3) :

- Instantaneous luminosity is expected to increase from $2 \cdot 10^{34} \text{ s}^{-1} \text{ cm}^{-2}$ up to $7.5 \cdot 10^{34} \text{ s}^{-1} \text{ cm}^{-2}$.
- Peak pile-up of up to 200 compared to 60 in the current run.

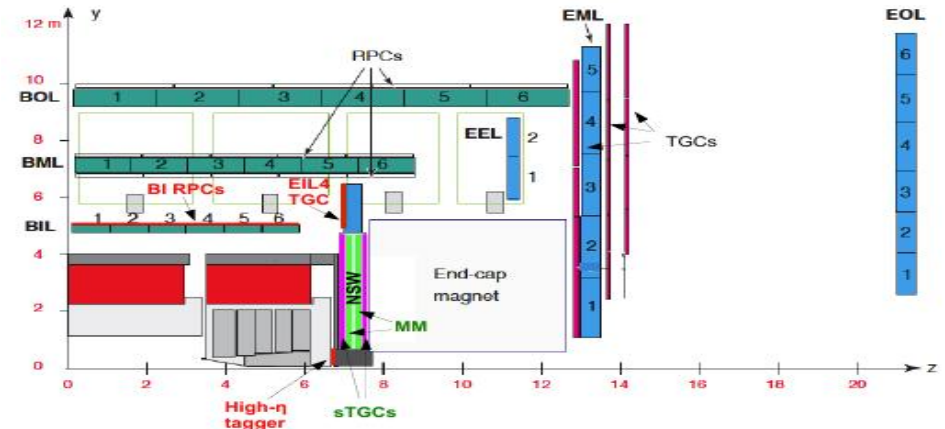
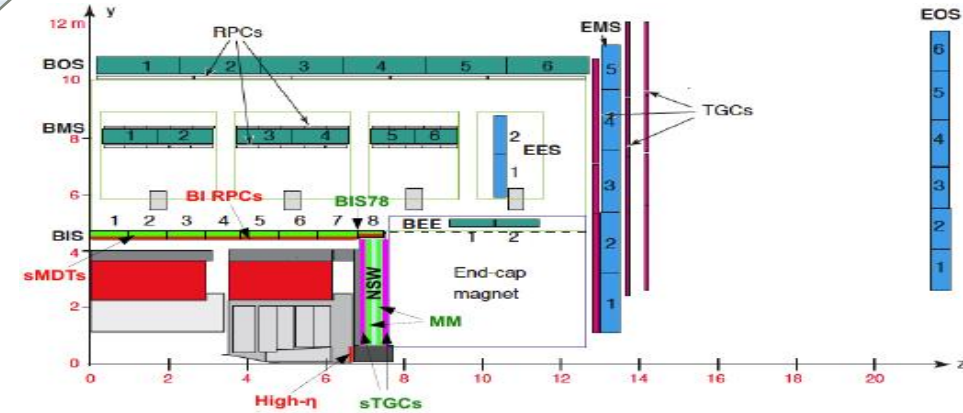
➔ Upgrade of ATLAS is necessary !

For the RPC system :

Maintain low trigger momentum thresholds while keeping the trigger rates at a manageable level

Install triplets of new-generation RPCs in the inner layer of barrel chambers (BI-RPC)

- 130 BIL + 96 BIS + 80 BOR/BOM chambers.
- 1 chamber is composed of 3 singlets.
- 1 singlet = 1 gas gap + 2 readout panels.

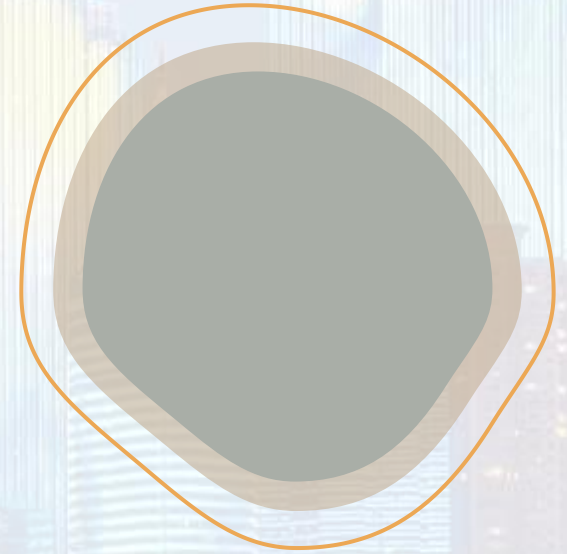
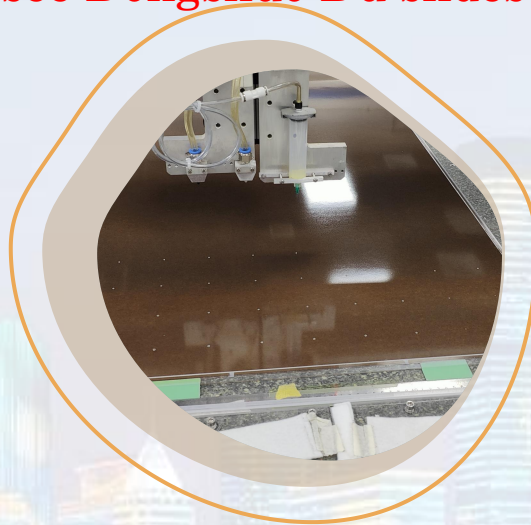
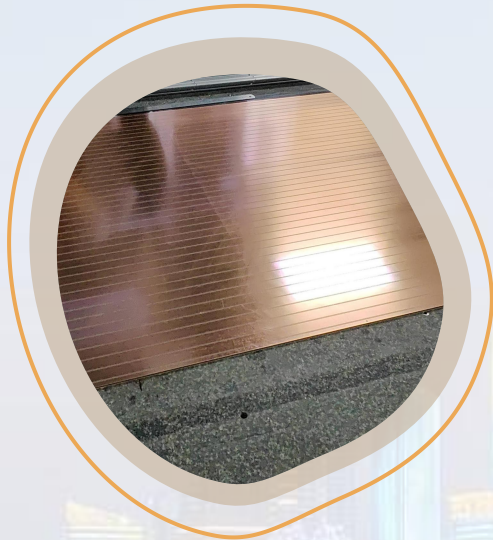


Tasks undertaken by the Chinese cluster (USTC/SDU/SJTU)

**Production and Qualification
of 72 gas gaps**

see **Dongshuo Du slides**

**Manufacture and test of about 5000
front-end boards**



**Production and Qualification
932 strip panels (50%)
(BIL/BIS/BOM/BOR)**

**Assembly of 360
singlets**

Production plan

Strip panels :

- 336/576 BIS panels have already been produced and qualified in China. The remained ones will be produced before the end of the the first semester 2025.

Gas Gaps :

- 7 RPC gas gaps has been produced by USTC and will be delivered to CERN for Irradiation test @ GIF++ in the following days

BIS Singlets :

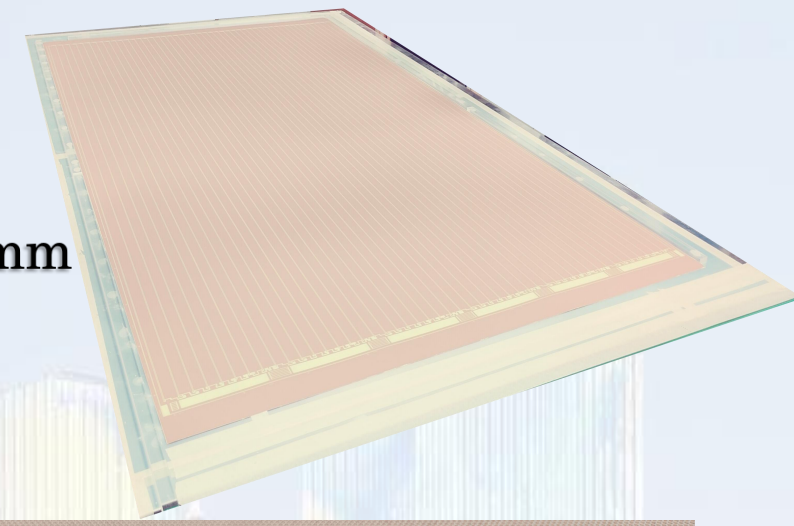
- BIS singlets assembly without FEE will start in the coming days @ CERN

Readout Panel Production



Material

- PBC : 1706x1072mm² (BIL) / 1706x890mm² (BIS)thickness ~0.45mm
- Honeycomb : 3 mm thick
- Glue : Araldite® 2011 (~180g/side)



Centrifugal Mixer
THINKY ARE-310



Araldite® 2011



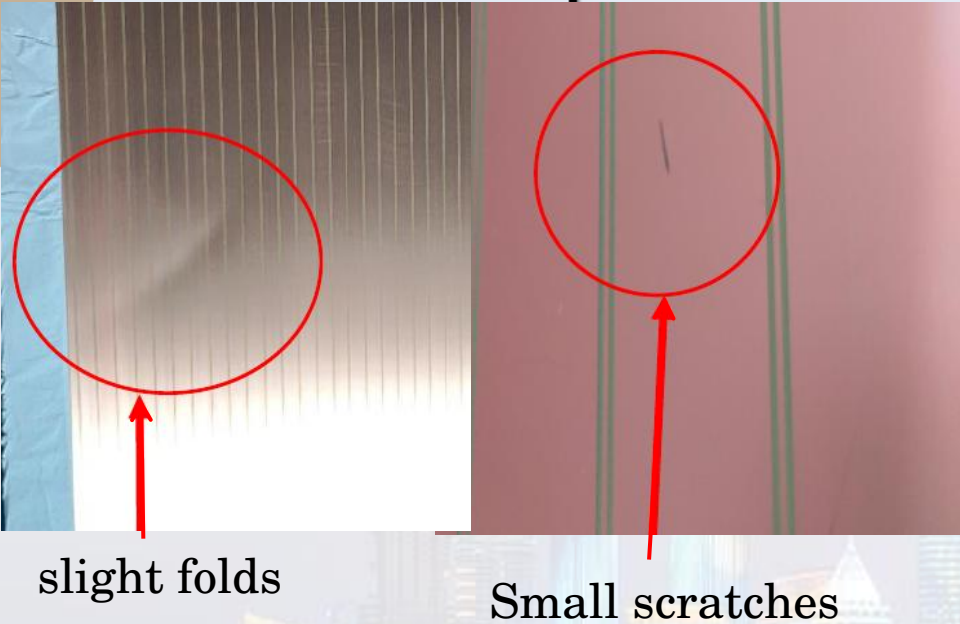
Cell size : 5 mm (side to side)
Density : 32 kg.m³

Specifications and tolerances

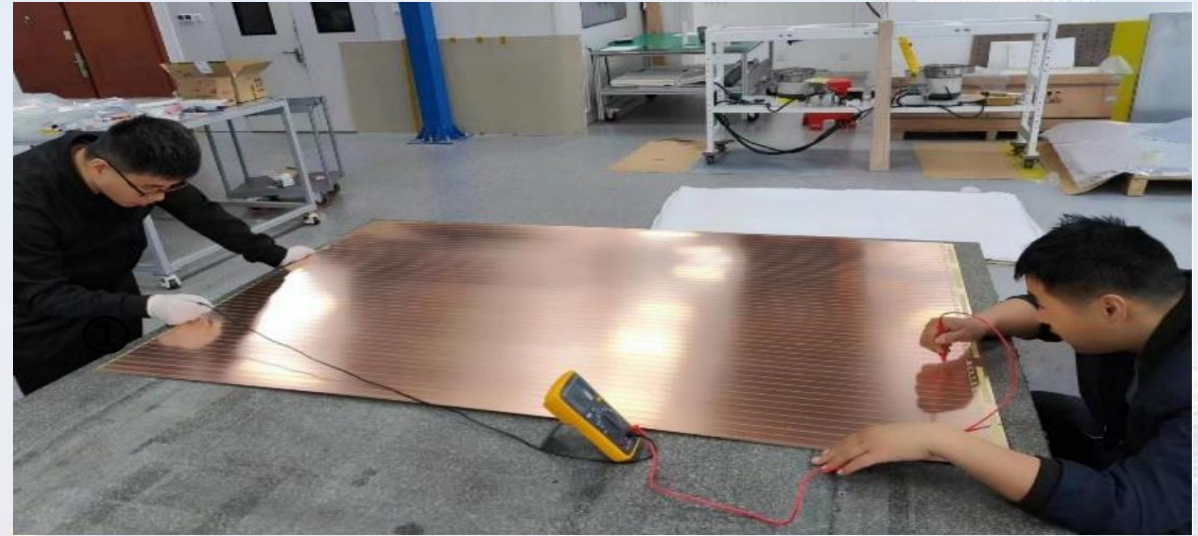
- **Flatness : < 0.1mm in 7cm x 7cm range**
- **Length and width : +/- 1mm**

PCBs Checks

Visual inspections



Electrical continuity checks

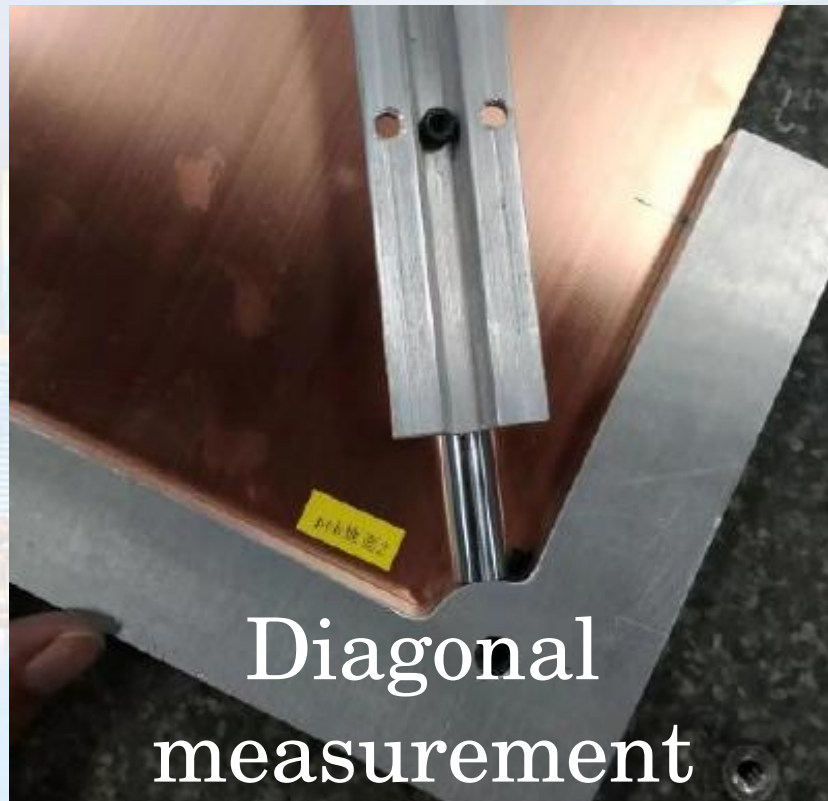
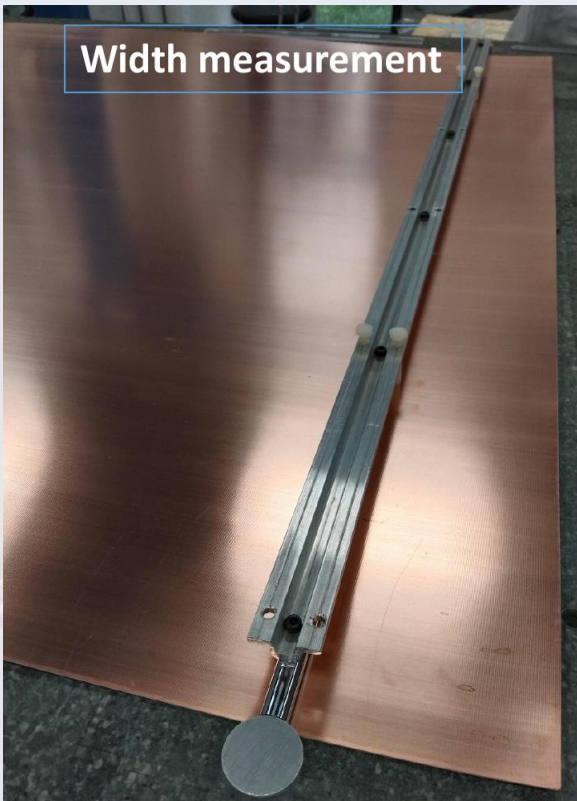


Dimension checks

Dimension Checks

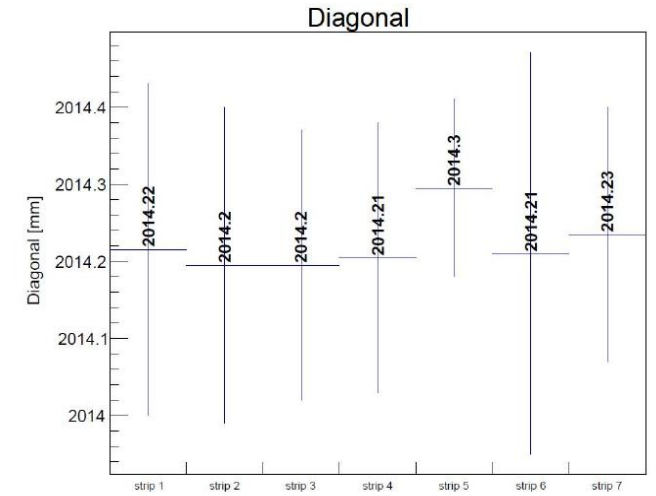
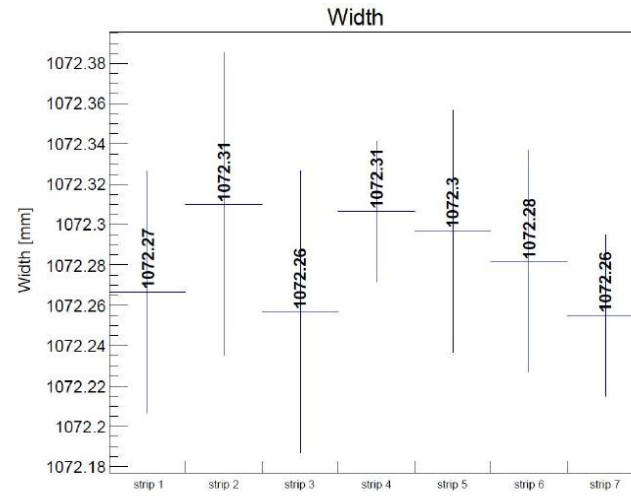
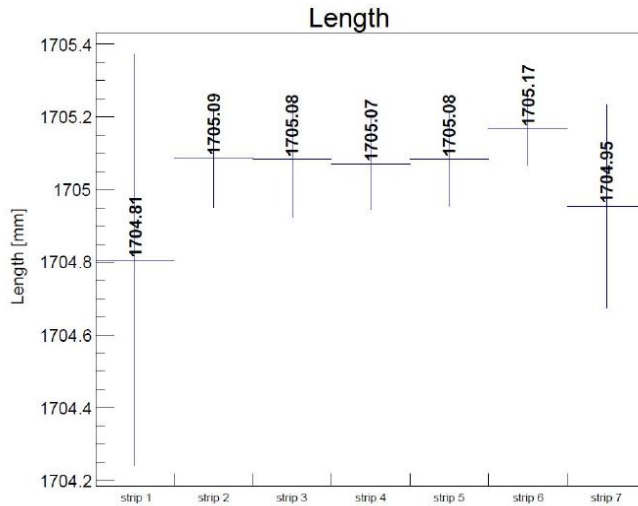


Three bars are used to perform dimension checks

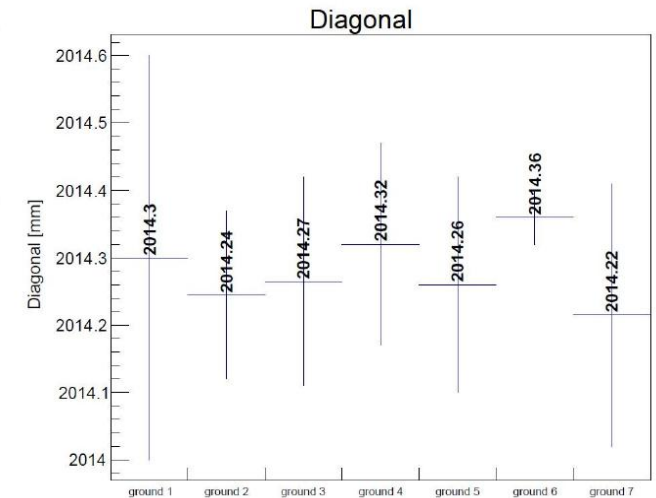
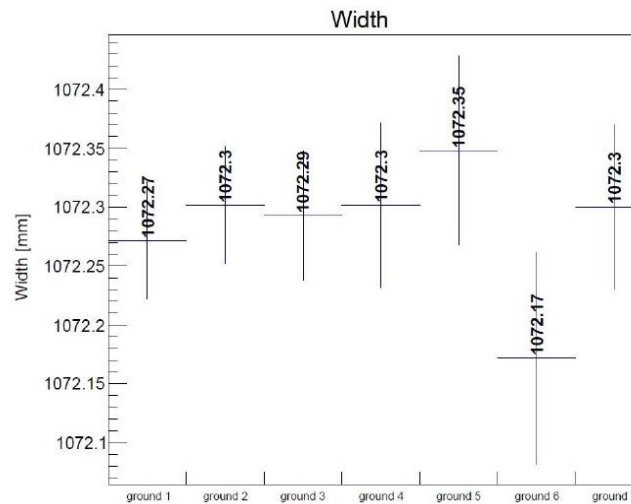
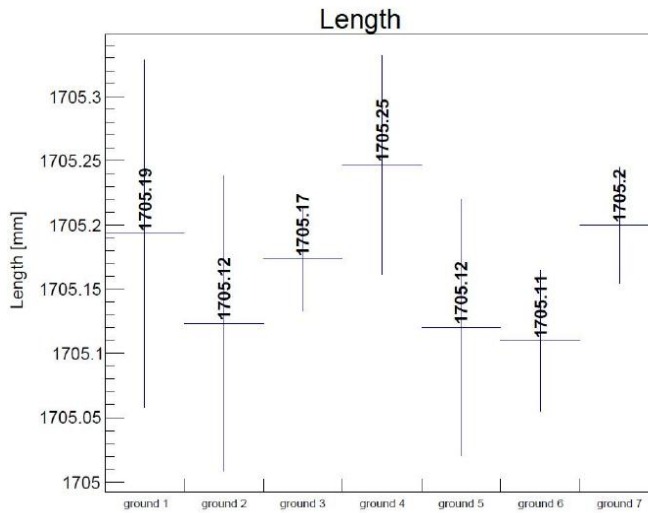


Results

Strip side



Ground side



All the measurements are within the tolerances

Honeycomb Paper Dimension Check

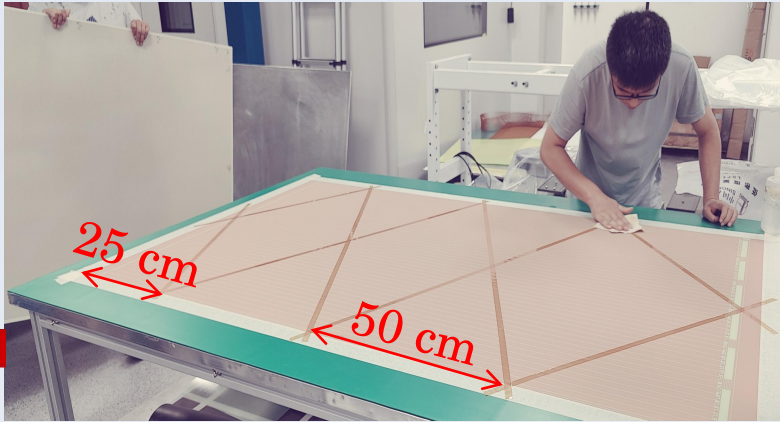
- Honeycomb paper size : 1220*2440*3mm²
- Thickness measurement is performed using a micrometer gauge on a marble table
- 5 samples has been tested : **All are good quality !**

#1	X ₁	X ₂	#2	X ₁	X ₂	#3	X ₁	X ₂
Y ₁	3.03	3.067	Y ₁	3.102	3.091	Y ₁	3.062	3.043
Y ₂	3.05	3.07	Y ₂	3.087	3.076	Y ₂	3.066	3.065
Y ₃	3.036	3.067	Y ₃	3.072	3.049	Y ₃	3.057	3.049
Y ₄	3.022	3.074	Y ₄	3.078	3.067	Y ₄	3.064	3.044
Y ₅	3.05	3.067	Y ₅	3.07	3.041	Y ₅	3.06	3.057
Y ₆	3.038	3.055	Y ₆	3.071	3.043	Y ₆	3.068	3.059
Mean	3.038	3.067	Mean	3.08	3.061	Mean	3.063	3.053

#4	X ₁	X ₂	#5	X ₁	X ₂
Y ₁	3.039	3.076	Y ₁	3.107	3.103
Y ₂	3.063	3.074	Y ₂	3.096	3.099
Y ₃	3.054	3.082	Y ₃	3.074	3.097
Y ₄	3.061	3.092	Y ₄	3.079	3.097
Y ₅	3.075	3.088	Y ₅	3.106	3.107
Y ₆	3.078	3.079	Y ₆	3.106	3.119
Mean	3.062	3.082	Mean	3.095	3.104



Strip panel production



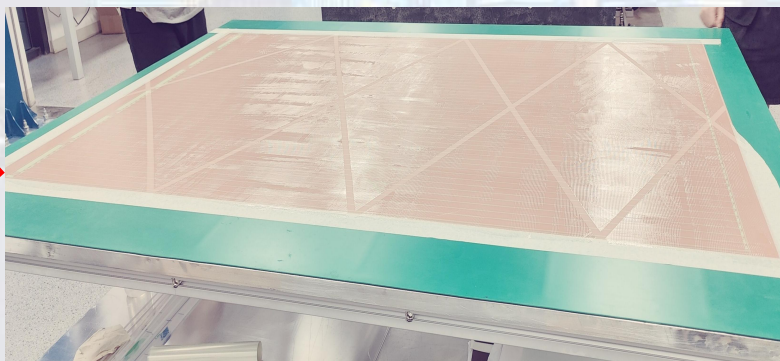
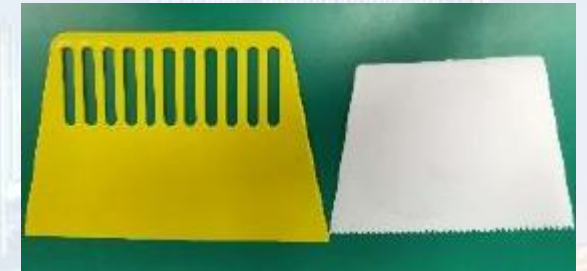
1) Create X shapes with tape on the strip and ground panels

- Distance between parallel tapes : 50 cm
- PCB edges are protected with 3mm tape mask



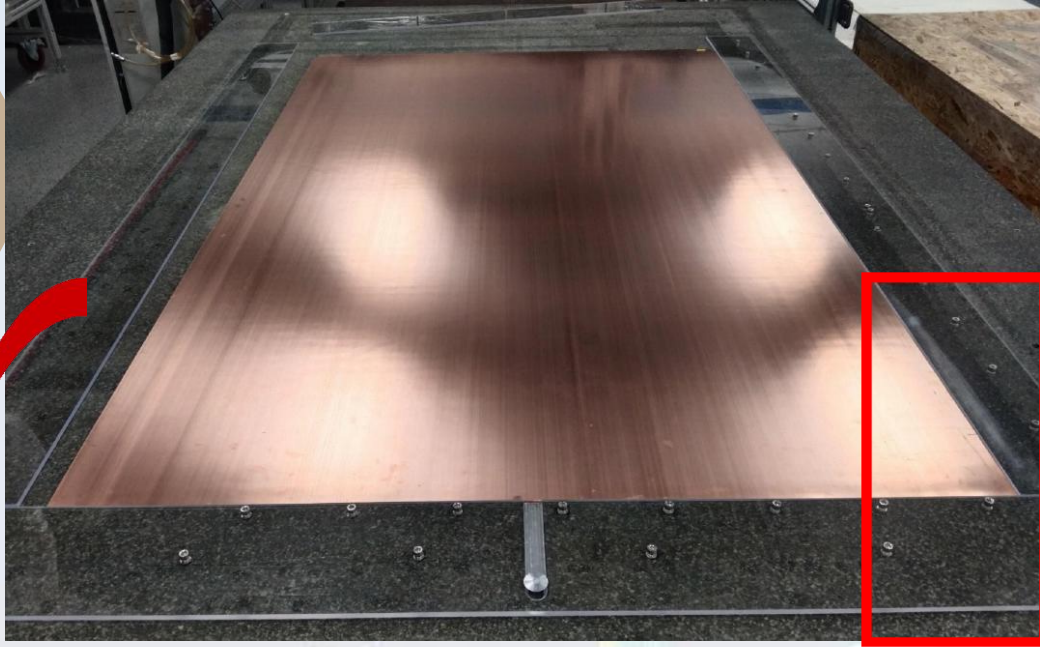
2) Apply the araldite glue on PCB

- Plastic spatula (yellow one) is used to spread the Araldite glue
- Plastic toothed spatula (white one) is used to improve glue layer uniformity.



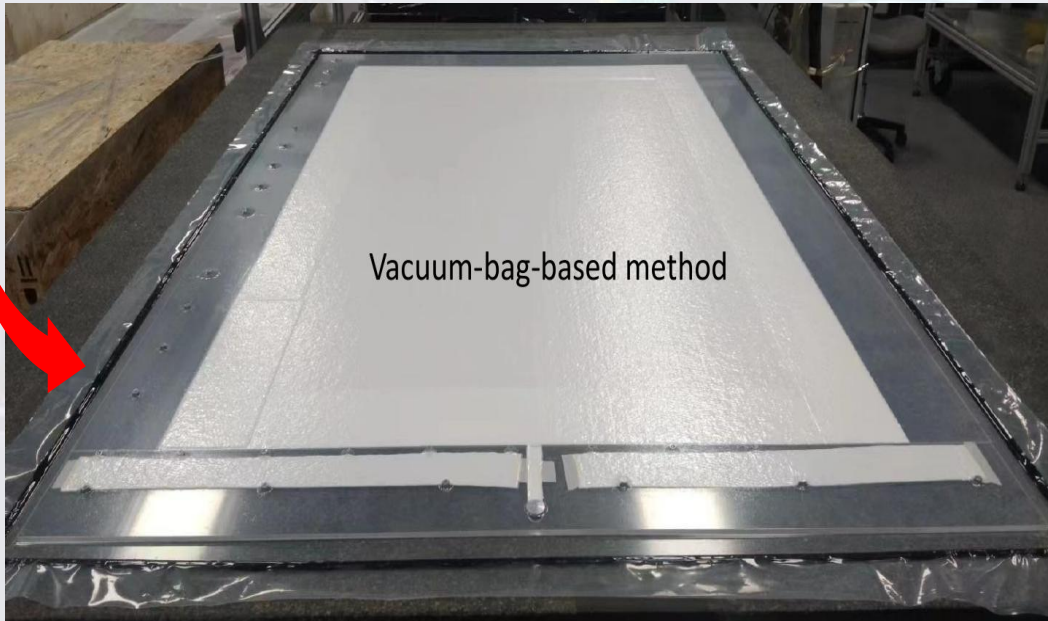
3) Removing of the X shapes and the 3mm edge tape mask

Strip panel production



4) Alignment of the 3 layers (2PCBs +Honeycomb)

**Very good alignment
All the layers glued at once**



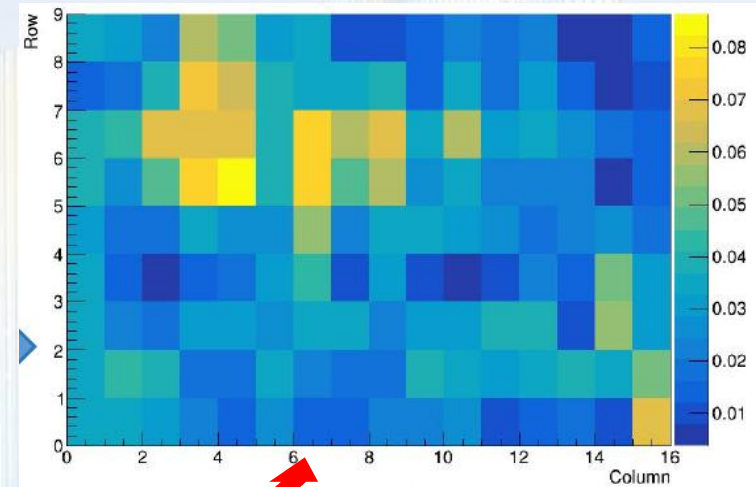
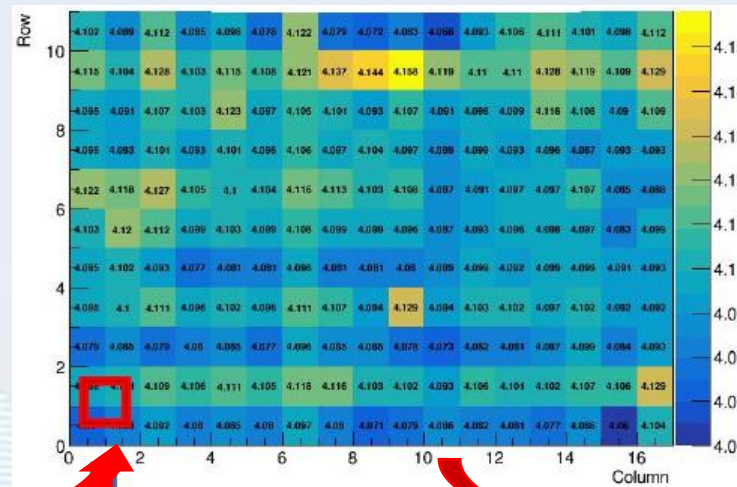
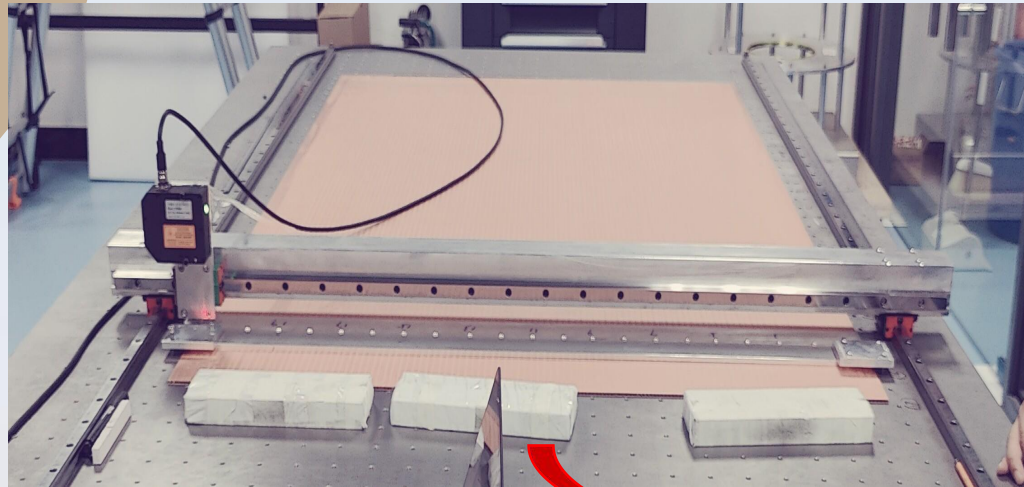
5) Gluing of the layers

- 1 atm vacuum
- 6 hours of curing within the vacuum bag

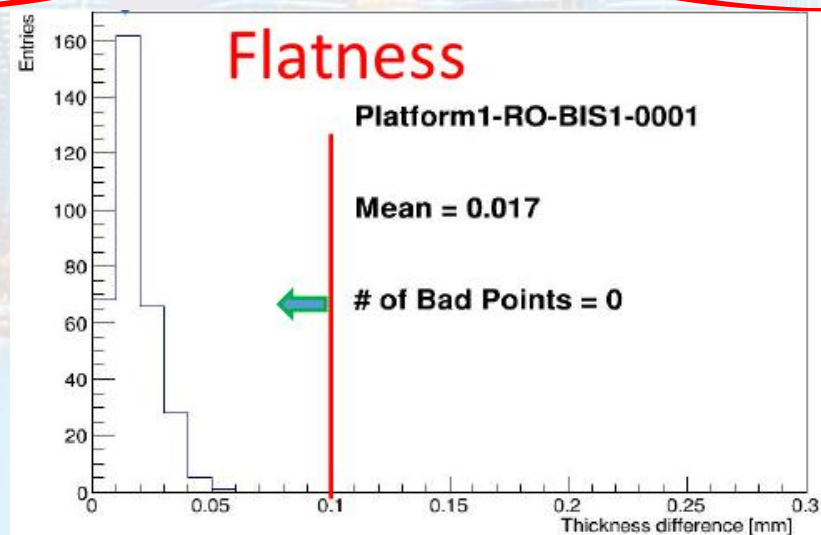
Good pressure uniformity all along the panel

Overall Panel Thickness Measurement

- The 3D thickness map is measure on $7*7\text{cm}^2$ cells basis by laser sensors
- The 2D Flatness (Maximum variation of 4 adjacent $7*7\text{cm}^2$ cells)
- Histogram of 1D Flatness

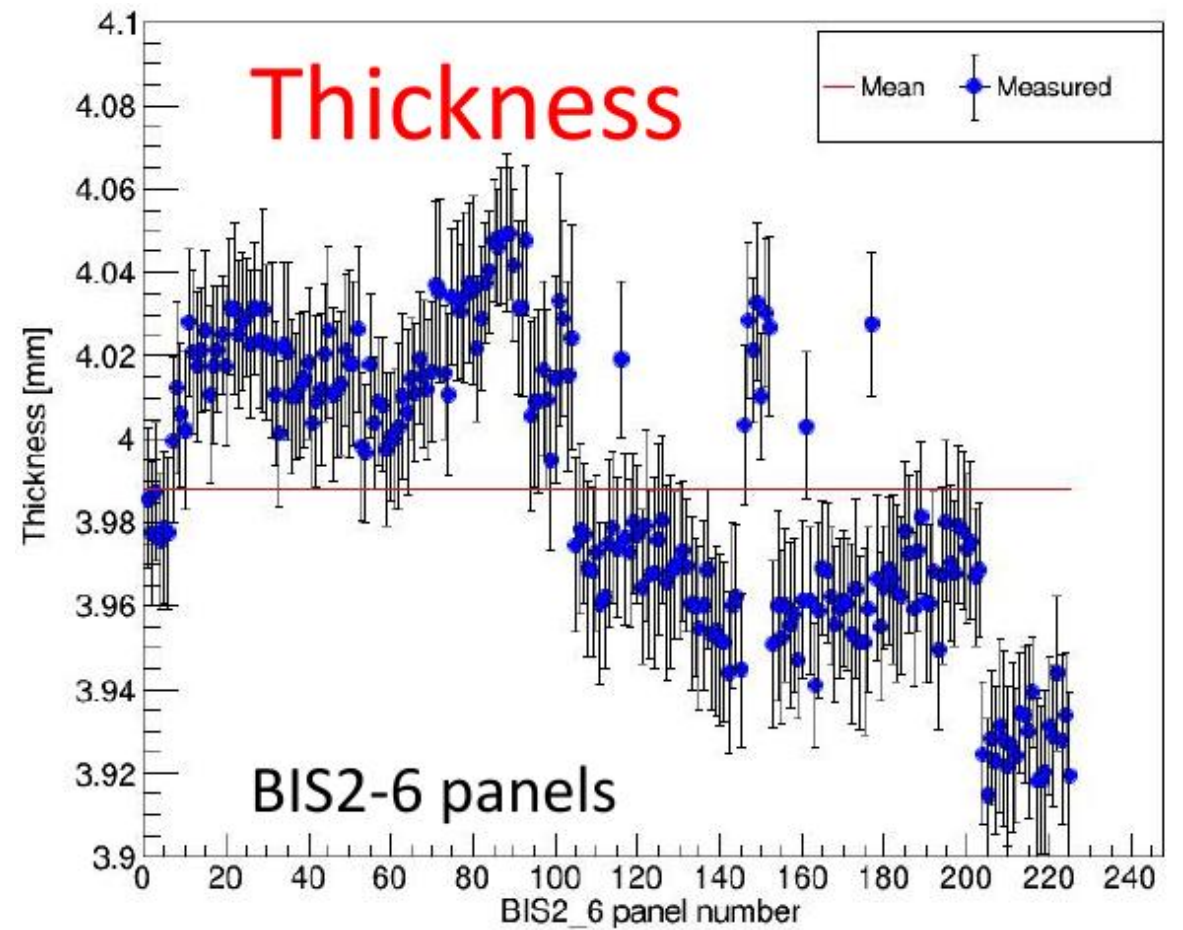
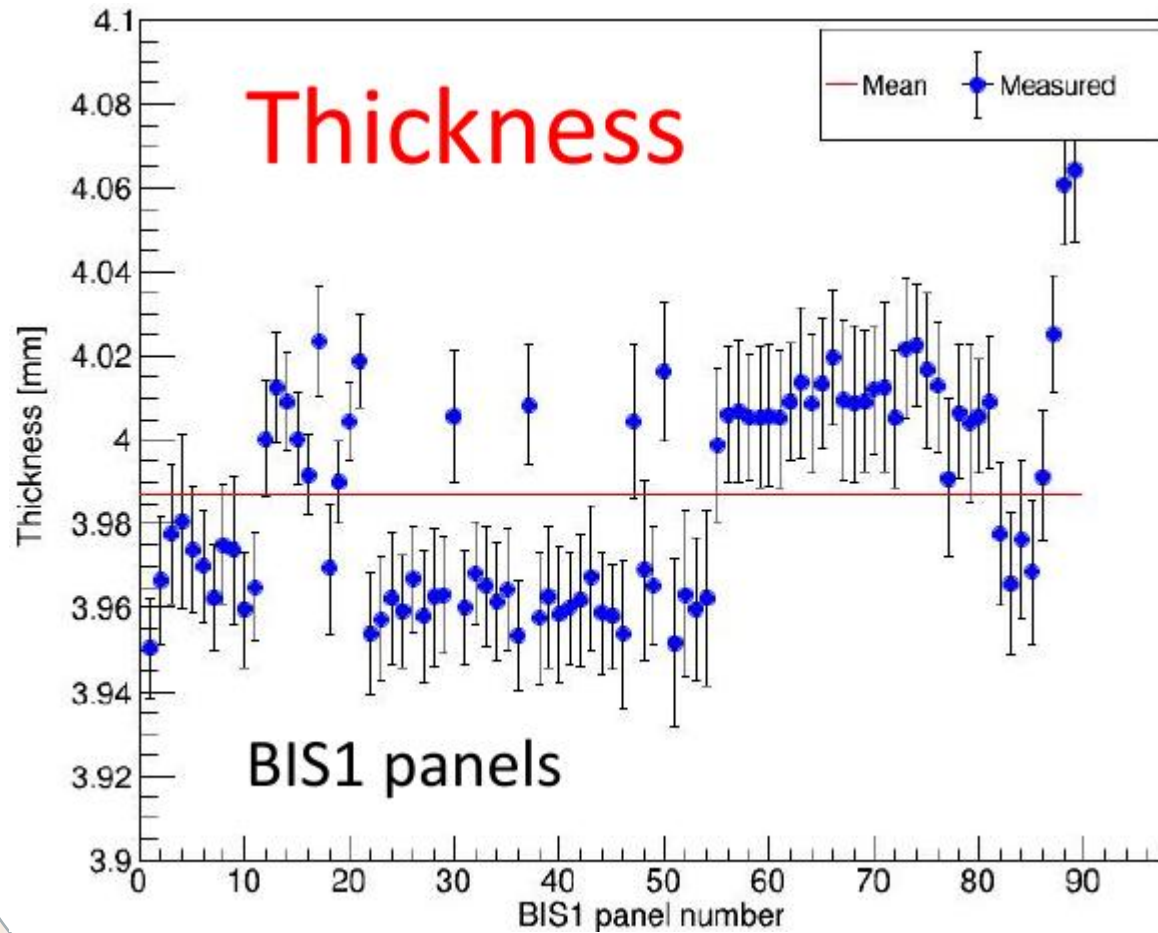


Requirement :
Flatness < 100 μm

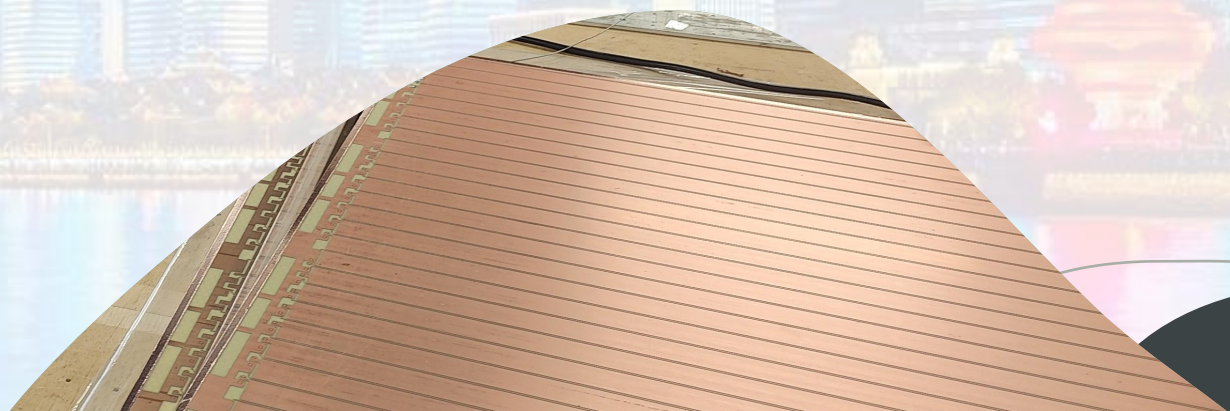


Panel Thickness Measurement

More than 300 readout panels have already been built by an external company :

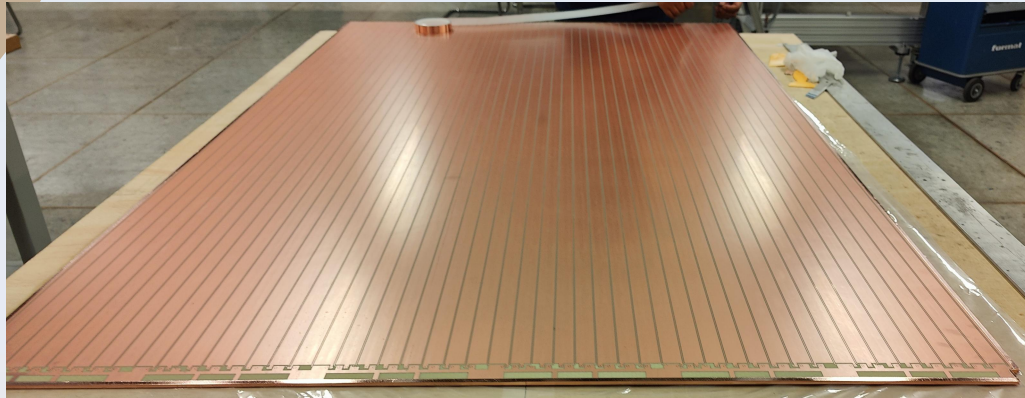


BIS Singlet Assembly

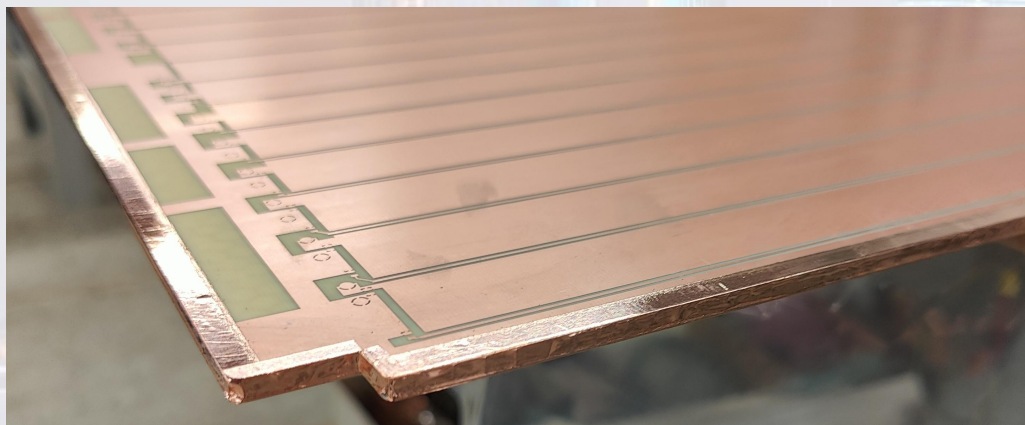


BIS singlet assembly

1. Connect the border of strips side to the ground side.
2. Solder the resistance at the 2 ends of the strips : **time consuming 1 strip panels 194 resistors (~1.5h), 1 singlet 388 resistors, one chamber 1164 resistors ! Moving to a new method using masks**



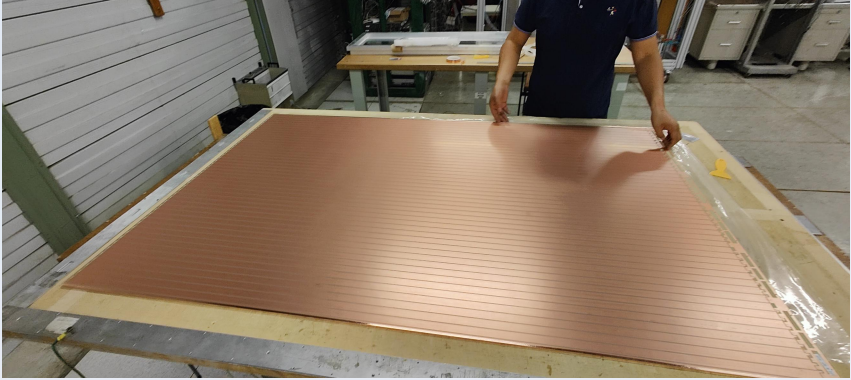
Mask plate



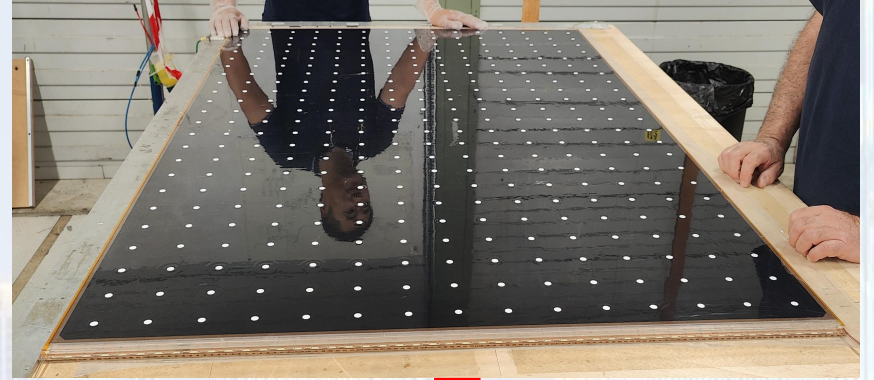
Solder paste

BIS singlet assembly

Put the readout panel on the table



Place the RPC chamber on top of the strip panel



Cover the borders with aluminium tape



Add the second strip panel



Production will start next week at CERN with a first batch of 24 BIS singlets !

Summary

Readout panel :

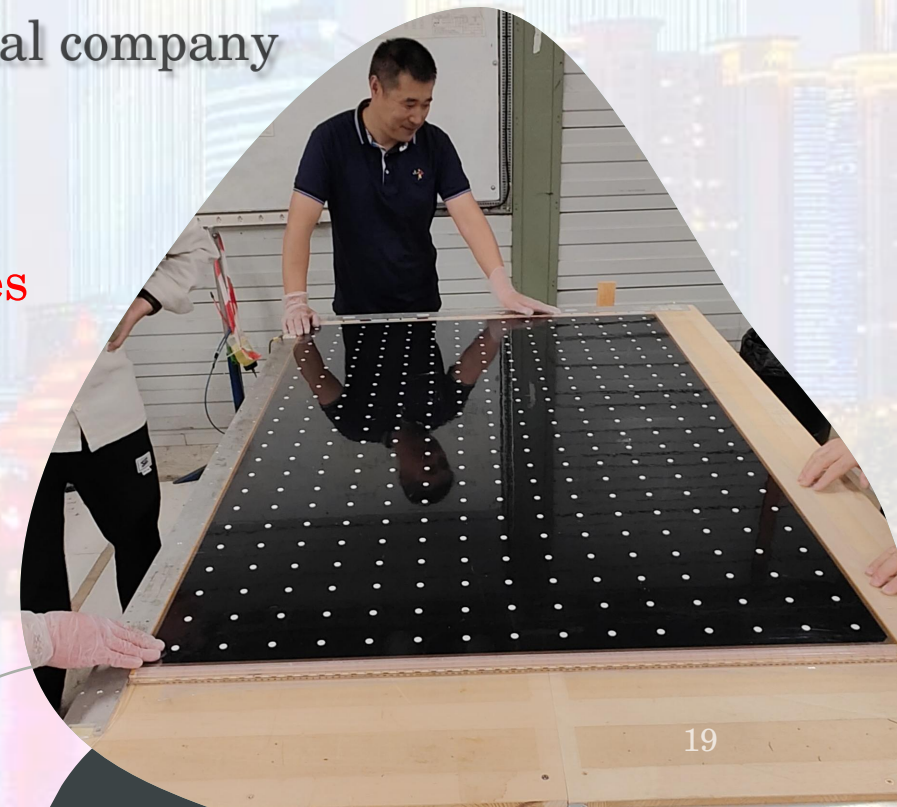
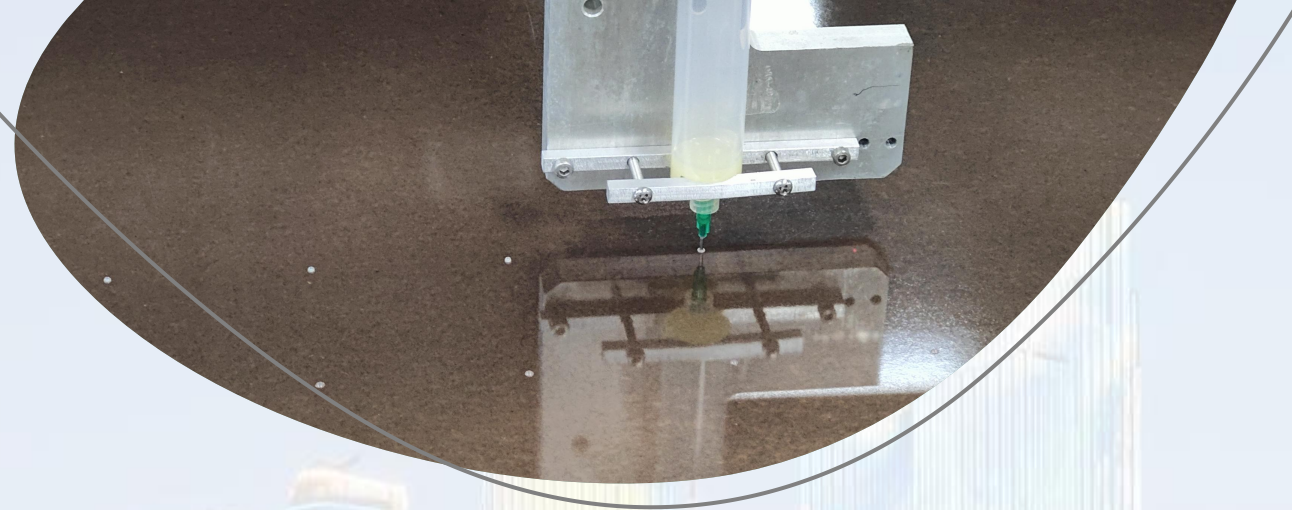
- The vacuum-bag method has been setup at USTC and further optimized.
- More than 500 readout panel have been produced in an external company
- The flatness is below the specification ($<100\text{ }\mu\text{m}$)

Gas gap production at USTC : [see Dongshuo Du slides](#)

- 7 $130*68\text{ cm}^2$ gas gap prototypes has been produced
- Ready to be tested under irradiation at GIF⁺⁺, CERN

BIS Singlet Assembly :

- Singlet assembly training will start next week at CERN





Thank You